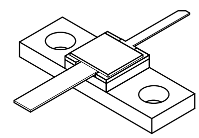
The RF Line
Microwave Power Transistor

MRF10005

. . . designed for CW and long pulsed common base amplifier applications, such as JTIDS and Mode S, in the 0.96 to 1.215 GHz frequency range at high overall duty cycles.

- Guaranteed Performance @ 1.215 GHz, 28 Vdc
  Output Power = 5.0 Watts CW
  Minimum Gain = 8.5 dB, 10.3 dB (Typ)
- RF Performance Curves given for 28 Vdc and 36 Vdc Operation
- 100% Tested for Load Mismatch at All Phase Angles with 10:1 VSWR
- Hermetically Sealed Industry Standard Package
- Silicon Nitride Passivated
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Internal Input Matching for Broadband Operation
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

**5.0 W, 960 – 1215 MHz
MICROWAVE POWER
TRANSISTOR
NPN SILICON**



CASE 336E–02, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CES}	55	Vdc
Collector–Base Voltage	V_{CBO}	55	Vdc
Emitter–Base Voltage	V_{EBO}	3.5	Vdc
Collector Current — Continuous (1)	I_C	1.25	mAdc
Total Device Dissipation @ T_A = 25°C (1) Derate above 25°C	P_D	25 143	Watt mW/°C
Storage Temperature Range	T_{stg}	–65 to +200	°C
Junction Temperature	T_J	200	°C

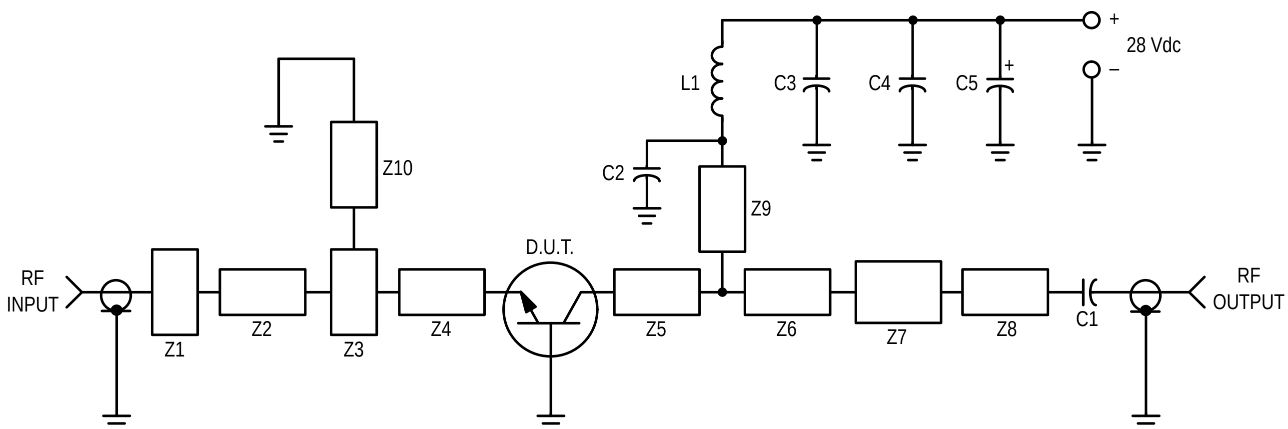
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (2)	$R_{\theta JC}$	7.0	°C/W

NOTES:
1. These devices are designed for RF operation. The total device dissipation rating applies only when the devices are operated as RF amplifiers.
2. Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 25 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	55	—	—	Vdc
Collector–Base Breakdown Voltage (I_C = 25 mAdc, I_E = 0)	$V_{(BR)CBO}$	55	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 0.5 mAdc, I_C = 0)	$V_{(BR)EBO}$	3.5	—	—	Vdc
Collector Cutoff Current (V_{CB} = 28 Vdc, I_E = 0)	I_{CBO}	—	—	1.0	mAdc
ON CHARACTERISTICS					
DC Current Gain (I_C = 500 mAdc, V_{CE} = 5.0 Vdc)	h_{FE}	20	—	100	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 28 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	7.0	10	pF
FUNCTIONAL TESTS					
Common–Base Amplifier Power Gain (V_{CC} = 28 Vdc, P_{out} = 5.0 W, f = 1215 MHz)	G_{PB}	8.5	10.3	—	dB
Collector Efficiency (V_{CC} = 28 Vdc, P_{out} = 5.0 W, f = 1215 MHz)	η	45	55	—	%
Load Mismatch (V_{CC} = 28 Vdc, P_{out} = 5.0 W, f = 1215 MHz, VSWR = 10:1 All Phase Angles)	ψ	No Degradation in Output Power			



C1, C2, C3 — 220 pF 100 mil Chip Capacitor
C4 — 0.1 μF
C5 — 47 μF/50 V Electrolytic
L1 — 3 turn #18 AWG, 1/8″ ID, 0.18″ Long

Z1–Z10 — Microstrip, see details below
Board Material — 0.030″ Glass Teflon, 2.0 oz. Copper, ε_r = 2.55

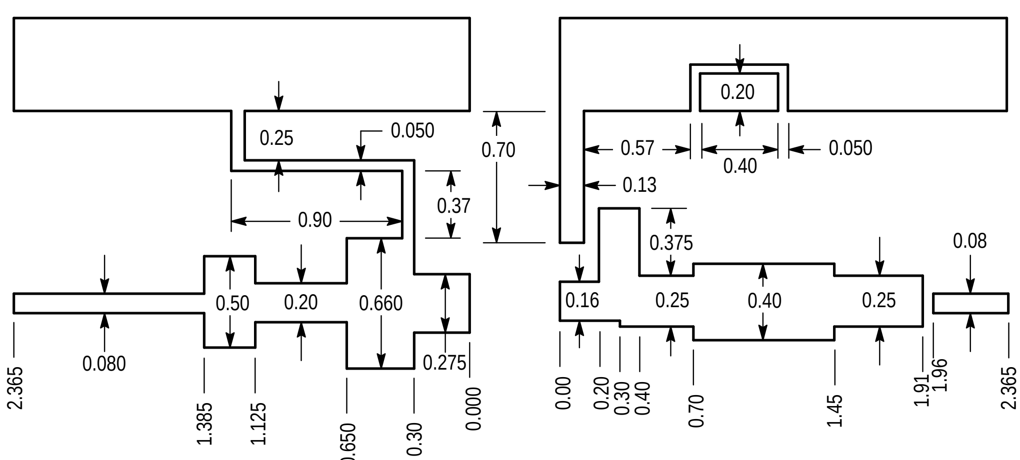


Figure 1. Test Circuit

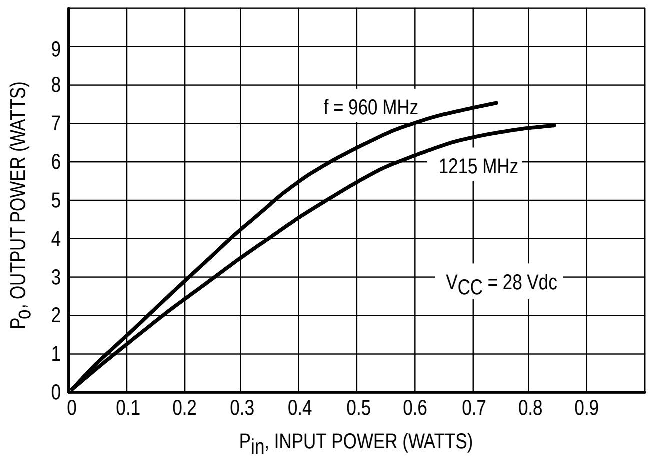


Figure 2. Output Power versus Input Power

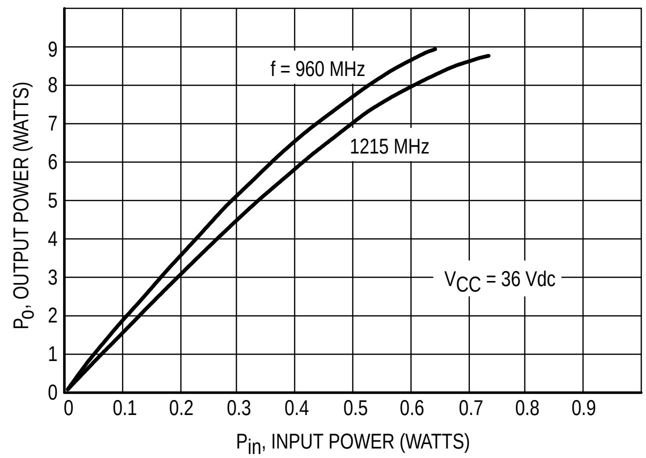
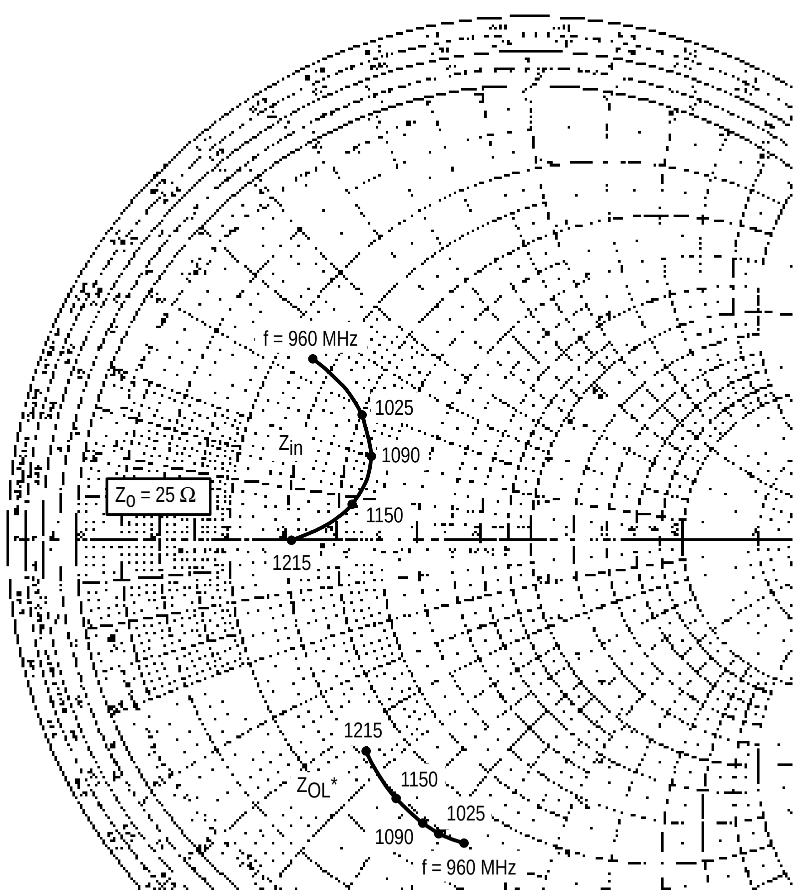


Figure 3. Output Power versus Input Power



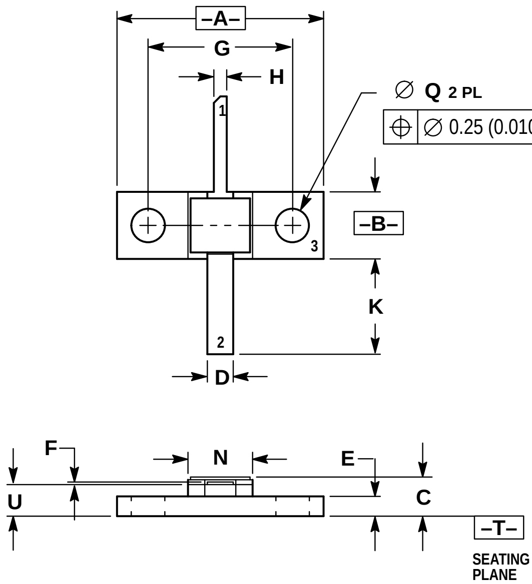
P_{out} = 5 W, V_{CC} = 28 V

f MHz	Z_{in} OHMS	Z_{OL}* OHMS
960	6.5 + j8.5	7.4 – j18.9
1025	10.0 + j7.0	7.2 – j17.4
1090	11.2 + j4.9	7.1 – j16.3
1150	10.8 + j2.0	7.15 – j14.3
1215	7.8 + j0.0	7.8 – j11.2

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 4. Series Equivalent Input/Output Impedances

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.790	0.810	20.07	20.57
B	0.253	0.267	6.43	6.78
C	0.144	0.160	3.66	4.06
D	0.093	0.107	2.37	2.71
E	0.074	0.080	1.88	2.03
F	0.002	0.006	0.06	0.15
G	0.560 BSC		14.22 BSC	
H	0.043	0.057	1.10	1.44
K	0.346	0.394	8.79	10.10
N	0.243	0.257	6.18	6.52
Q	0.125	0.135	3.18	3.42
U	0.117	0.128	2.98	3.25

STYLE 1:
PIN 1. COLLECTOR
2. EMITTER
3. BASE

CASE 336E–02
ISSUE B

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